

Vishay High Power Products

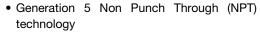
INT-A-PAK "Half-Bridge" (Ultrafast Speed IGBT), 108 A



INT-A-PAK

PRODUCT SUMMARY				
V _{CES}	600 V			
I _C DC	108 A			
V _{CE(on)} at 100 A, 25 °C	2.6 V			

FEATURES





· Ultrafast: Optimized for hard switching speed 8 kHz to 60 kHz

- Low V_{CE(on)}
- 10 µs short circuit capability
- Square RBSOA
- Positive V_{CE(on)} temperature coefficient
- HEXFRED® antiparallel diode with ultrasoft reverse recovery characteristics
- Industry standard package
- Al₂O₃ DBC
- UL approved file E78996



- Compliant to RoHS directive 2002/95/EC
- Designed for industrial level

BENEFITS

- Benchmark efficiency for UPS and welding application
- Rugged transient performance
- Direct mounting on heatsink
- Very low junction to case thermal resistance

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS	
Collector to emitter voltage	V _{CES}		600	V	
Continuous collector current		T _C = 25 °C	108		
Continuous collector current	I _C	T _C = 80 °C	74		
Pulsed collector current	I _{CM}		200	А	
Clamped inductive load current	I _{LM}		200		
Diode continuous forward current		T _C = 25 °C	106		
	IF	T _C = 80 °C	69		
Gate to emitter voltage	V _{GE}		± 20	V	
Maximum power dissipation	Б	T _C = 25 °C	390	W	
	P_D	T _C = 80 °C	219	VV	
Isolation voltage	V _{ISOL}	Any terminal to case, t = 1 min	2500	V	

GB100TS60NPbF

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ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Collector to emitter breakdown voltage	V _{BR(CES)}	$V_{GE} = 0 \text{ V}, I_{C} = 500 \mu\text{A}$	600	-	-	
	V _{CE(on)}	V _{GE} = 15 V, I _C = 50 A	-	1.95	2.1	V
Collector to emitter valtage		V _{GE} = 15 V, I _C = 100 A	-	2.6	2.85	
Collector to emitter voltage		V _{GE} = 15 V, I _C = 50 A, T _J = 125 °C	-	2.21	2.44	
		V _{GE} = 15 V, I _C = 100 A, T _J = 125 °C	-	3.05	3.38	
Gate threshold voltage	V _{GE(th)}	$V_{CE} = V_{GE}$, $I_C = 500 \mu A$	3	4.6	6	
Collector to emitter leakage current	I _{CES}	V _{GE} = 0 V, V _{CE} = 600 V	-	0.01	0.1	mA
Collector to emitter leakage current		V _{GE} = 0 V, V _{CE} = 600 V, T _J = 150 °C	-	3.7	10	IIIA
Diode forward voltage drop	V _{FM}	I _C = 50 A	-	1.35	1.66	V
		I _C = 100 A	-	1.57	1.96	
		I _C = 50 A, T _J = 125 °C	-	1.27	1.50	
		I _C = 100 A, T _J = 125 °C	-	1.57	1.89	
Gate to emitter leakage current	I _{GES}	V _{GE} = ± 20 V	-	-	± 200	nA

SWITCHING CHARACTERISTICS (T _J = 25 °C unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Turn-on switching loss	E _{on}		-	0.6	-	
Turn-off switching loss	E _{off}	$I_C = 100 \text{ A}, V_{CC} = 360 \text{ V}, V_{GE} = 15 \text{ V},$ $R_0 = 4.7 \Omega, L = 200 \mu\text{H}, T_J = 25 ^{\circ}\text{C}$	-	1.1	-	
Total switching loss	E _{tot}	- 1 γ - 1 22, 2 - 200 μπ, 1 γ - 20 0	-	1.7	-	
Turn-on switching loss	E _{on}		-	0.8	-	- mJ
Turn-off switching loss	E _{off}		-	1.3	-	
Total switching loss	E _{tot}		-	2.1	-	
Turn-on delay time	t _{d(on)}	$I_C = 100 \text{ A}, V_{CC} = 360 \text{ V}, V_{GE} = 15 \text{ V},$ $R_a = 4.7 \Omega, L = 200 \mu\text{H}, T_J = 125 ^{\circ}\text{C}$	-	197	-	
Rise time	t _r	- 1.1g = 22, Σ = 200 μπ, 1, 1 = 120 0	-	50	-	
Turn-off delay time	t _{d(off)}		-	225	-	ns
Fall time	t _f		-	72	-	
Reverse bias safe operating area	RBSOA	$T_J = 150 ^{\circ}\text{C}, I_C = 200 \text{A},$ $R_g = 27 \Omega, V_{GE} = 15 \text{V to } 0$	Fullsquare			
Short circuit safe operating area	SCSOA	$T_J = 150 ^{\circ}\text{C}, V_{CC} = 400 \text{V}, V_P = 600 \text{V}, \\ R_g = 27 \Omega, V_{GE} = 15 \text{V to } 0$	10	-	-	
Diode reverse recovery time	t _{rr}		-	116	140	ns
Diode peak reverse current	I _{rr}	$I_F = 50 \text{ A}, dI_F/dt = 200 \text{ A/}\mu\text{s},$ $V_{CC} = 400 \text{ V}, T_J = 25 ^{\circ}\text{C}$	-	11	15	Α
Diode recovery charge	Q _{rr}	V(C = 100 V, 1) = 20 0	-	600	1050	nC
Diode reverse recovery time	t _{rr}		-	152	190	ns
Diode peak reverse current	I _{rr}	$I_F = 50 \text{ A}, dI_F/dt = 200 \text{ A/}\mu\text{s},$ $V_{CC} = 400 \text{ V}, T_J = 125 ^{\circ}\text{C}$	-	16	20	Α
Diode recovery charge	Q _{rr}	1 100 100 1, 1, 1, 120 0	-	1215	1900	nC



INT-A-PAK "Half-Bridge" Vishay High Power Products (Ultrafast Speed IGBT), 108 A

THERMAL AND MECHANICAL SPECIFICATIONS						
PARAMETER		SYMBOL	MIN.	TYP.	MAX.	UNITS
Operating junction and storage temperature range		T _J , T _{Stg}	- 40	-	150	°C
Junction to case per leg	IGBT	R_{thJC}	-	0.23	0.32	°C/W
	Diode		-	0.38	0.64	
Case to sink per module		R _{thCS}	-	0.1	-	
Mounting torque	case to heatsink		-	-	4	Nm
	case to terminal 1, 2, 3		-	-	3	
Weight			-	185	-	g

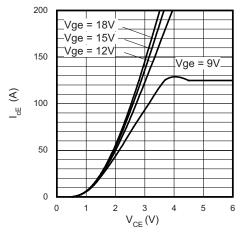


Fig. 1 - Typical IGBT Output Characteristics T_J = 25 °C, t_p = 500 μs

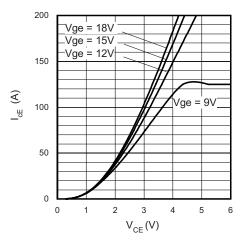


Fig. 2 - Typical IGBT Output Characteristics $T_J = 125~^{\circ}C,\, t_p = 500~\mu s$

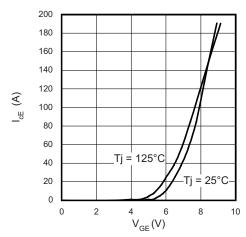


Fig. 3 - Typical Transfer Characteristics V_{CE} = 20 V, t_p = 500 μs

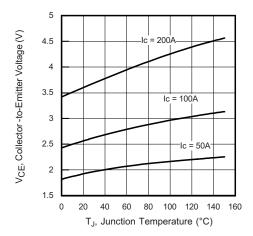


Fig. 4 - Typical Collector to Emitter Voltage vs. Junction Temperature, $V_{GE} = 15 \text{ V}, 500 \ \mu \text{s} \ \text{pulse} \ \text{width}$

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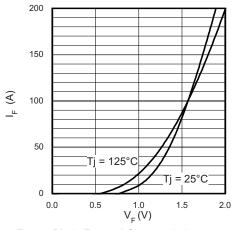


Fig. 5 - Diode Forward Characteristics, t_p = 500 μs

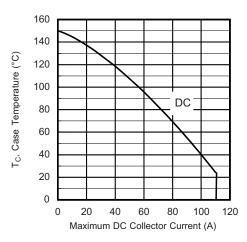


Fig. 6 - Maximum Collector Current vs. Case Temperature

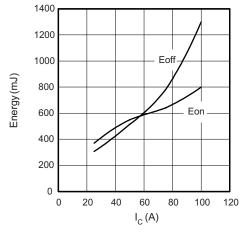


Fig. 7 - Typical Energy Loss vs. I_C, T_J = 125 °C, L = 200 μ H, V_{CC} = 360 V, R_g = 4.7 Ω , V_{GE} = 15 V

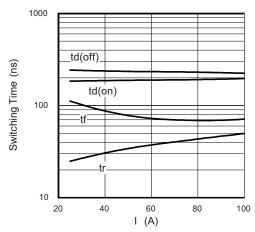
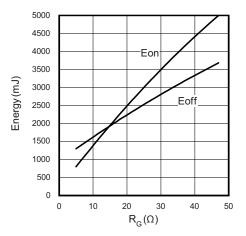


Fig. 8 - Typical Switching Time vs. I_C T $_J$ = 125 °C, L = 200 μ H, V_{CC} = 360 V, R_g = 4.7 Ω , V_{GE} = 15 V



 $\begin{aligned} &\text{Fig. 9 - Typical Energy Loss vs. } R_g \\ T_J &= 125 \text{ ^{\circ}C}, \text{ L} = 200 \text{ } \mu\text{H}, \text{ V}_{CC} = 360 \text{ V}, \\ I_{CE} &= 100 \text{ A}, \text{ V}_{GE} = 15 \text{ V} \end{aligned}$

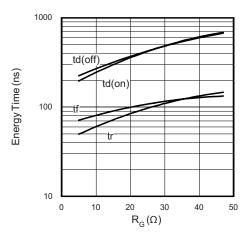


Fig. 10 - Typical Switching Time vs. R_g T_J = 125 °C, L = 200 μ H, V_{CC} = 360 V, I_{CE} = 100 A, V_{GE} = 15 V



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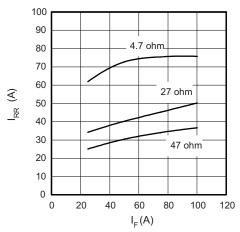


Fig. 11 - Typical Diode I_{rr} vs. I_{F} , T_{J} = 125 °C

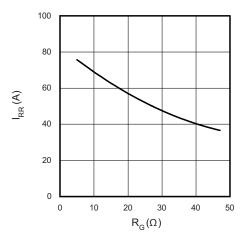


Fig. 12 - Typical Diode I_{rr} vs. R_g , $T_J = 125~^{\circ}C$, $I_F = 100~A$

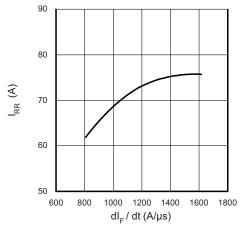


Fig. 13 - Typical Diode I_{rr} vs. $dI_F/dt,$ T_J = 125 °C, V_{CC} = 360 V, I_F = 150 A, V_{GE} = 15 V

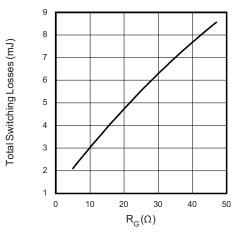


Fig. 14 - Typical Switching Losses vs. Gate Resistance, T $_J$ = 125 °C, L = 200 $\mu H,~R_g$ = 10 $\Omega,$ V $_{CC}$ = 360 V, V $_{GE}$ = 15 V

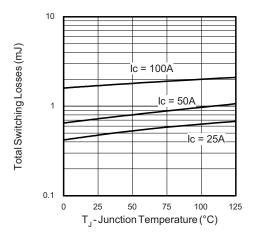


Fig. 15 - Typical Switching Losses vs. Junction Temperature, L = 200 μ H, R_q = 10 Ω , V_{CC} = 360 V, V_{GE} = 15 V

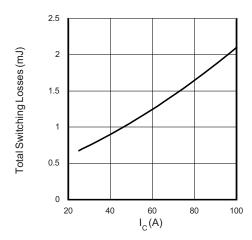


Fig. 16 - Typical Switching Losses vs. Collector to Emitter Current, $T_J=125~^{\circ}C,~R_{g1}=4.7~V,~R_{g2}=0~\Omega,~V_{CC}=360~V,~V_{GE}=15~V$

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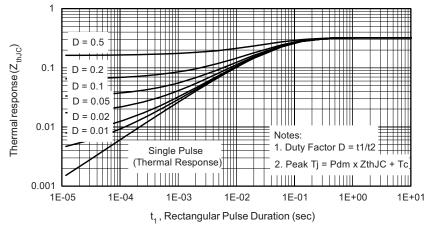


Fig. 17 - Maximum Transient Thermal Impedance, Junction to Case (IGBT)

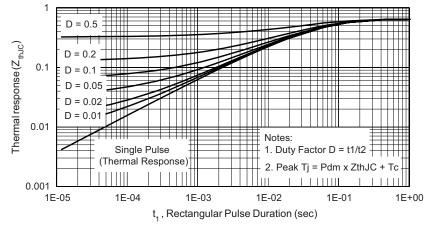


Fig. 18 - Maximum Transient Thermal Impedance, Junction to Case (HEXFRED®)

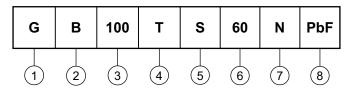


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ORDERING INFORMATION TABLE

Device code



Insulated Gate Bipolar Transistor (IGBT)

B = IGBT Generation 5 NPT

3 - Current rating (100 = 100 A)

- Circuit configuration (T = Half-bridge)

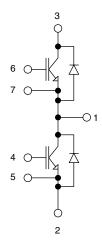
5 - Package indicator (S = INT-A-PAK)

6 - Voltage rating (60 = 600 V)

7 - Speed/type (N = Ultrafast IGBT)

8 - Lead (Pb)-free

CIRCUIT CONFIGURATION



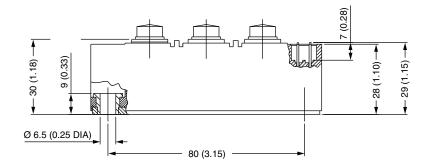
LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95173			

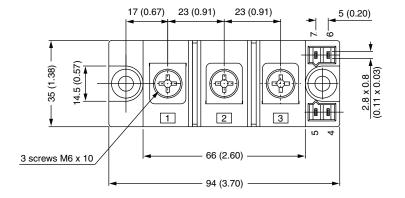


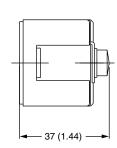
Vishay Semiconductors

INT-A-PAK IGBT/Thyristor

DIMENSIONS in millimeters (inches)











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Document Number: 91000 www.vishay.com Revision: 11-Mar-11